

Vishay Semiconductors

INT-A-PAK Power Modules Ultrafast Diodes, 300 A

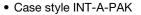


INT-A-PAK

PRODUCT SUMMARY				
I _{F(AV)} at T _C	300 A at 48 °C			
V_{R}	600 V			
t _{rr} (typical)	130 ns			
I _{F(DC)} at T _C	230 A at 100 °C			

FEATURES

- Electri
- 3500 V_{RMS} isolating voltage
- Standard JEDEC package
- Simplified mechanical designs, rapid assembly
- High surge capability
- Large creepage distances
- UL approved file E78996





• Designed and qualified for industrial level

	[A _{0.1}]
ically insulated by DBC ceramic	Pb-free
	Pb-free

Pb-free		
RoHS		
COMPLIANT		

ABSOLUTE MAXIMUM RATINGS					
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS	
Cathode to anode voltage	V_R		600	V	
Continuous forward surrent per les		T _C = 25 °C	435		
Continuous forward current per leg	IF	T _C = 100 °C	230	Α	
Single pulse forward current	I _{FSM}	Limited by junction temperature	TBD		
Maximum power dissipation per leg	P _D	T _C = 25 °C	781	W	
Maximum power dissipation per leg		T _C = 100 °C	313		
Operating junction and storage temperature range	T _J , T _{Stg}		- 40 to 150	°C	
RMS insulation voltage	V _{INS}	50 Hz, circuit to base, all terminals shorted, t = 1 s	3500	V	

ELECTRICAL SPECIFICATIONS (T _J = 25 °C unless otherwise specified)						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Cathode to anode breakdown voltage	V_{BR}	I _R = 500 μA	600	-	-	
Forward voltage drop per leg	V _{FM}	I _F = 150 A	-	1.23	1.53	
		I _F = 300 A	-	1.43	1.96	V
		I _F = 150 A, T _J = 125 °C	-	1.11	1.29	
		I _F = 300 A, T _J = 125 °C	-	1.39	1.73	
Maximum reverse leakage current	I _{RM}	T _J = 150 °C, V _R = 600 V	-	-	50	mA

VSKCU300/06PbF

Vishay Semiconductors

INT-A-PAK Power Modules Ultrafast Diodes, 300 A



Document Number: 93155

Revision: 18-May-10

DYNAMIC RECOVERY CHARACTERISTICS (T _J = 25 °C unless otherwise specified)							
PARAMETER	SYMBOL	TEST CO	MIN.	TYP.	MAX.	UNITS	
B		T _J = 25 °C	I _F = 50 A dl/dt = 200 A/μs V _R = 400 V (per leg)	-	130	165	ns
Reverse recovery time	t _{rr}	T _J = 125 °C		-	195	260	
Dools woodstown a suggest		T _J = 25 °C		-	11	18	A nC
Peak recovery current	I _{rr}	T _J = 125 °C		=	20	30	
Reverse recovery charge	0	T _J = 25 °C		=	670	1485	
	Q _{rr}	T _J = 125 °C		-	1800	3900	
Peak rate of recovery current	dI _{(rec)M} /dt	T _J = 125 °C		-	-	400	A/µs
Coffee and footon manufacture		I _F = 50 A, T _J = 25 °C, dl.	$/dt = 400 \text{ A/}\mu\text{s}, V_{R} = 200 \text{ V}$	-	0.2	-	
Softness factor per leg s		$I_F = 50 \text{ A}, T_J = 125 ^{\circ}\text{C}, dI/dt = 400 \text{A/}\mu\text{s}, V_R = 200 \text{V}$		-	0.22	-	

THERMAL AND MECHANICAL SPECIFICATIONS					
PARAMETER		SYMBOL	TEST CONDITIONS	VALUES	UNITS
Maximum junction operating and storage temperature range		T _J , T _{Stg}		- 40 to 150	°C
Maximum thermal rijunction to case per	•	R _{thJC}	DC operation	0.16	K/W
Typical thermal resistance, case to heatsink		R _{thCS}	Mounting surface, flat, smooth and greased	0.05	FV VV
Mounting	to heatsink		A mounting compound is recommended and the torque should be rechecked after a period of	4 to 6	Nm
torque ± 10 %	busbar		3 hours to allow the spread of the compound.	4 10 0	INIII
Approximate weight				200	g
				7.1	OZ.
Case style				INT-A	-PAK





INT-A-PAK Power Modules Ultrafast Diodes, 300 A

Vishay Semiconductors

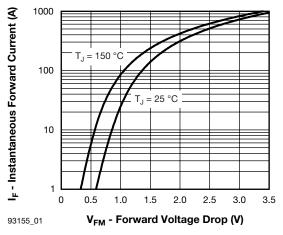


Fig. 1 - Maximum Forward Voltage Drop Characteristics

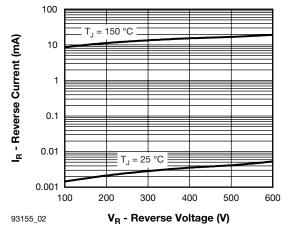


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

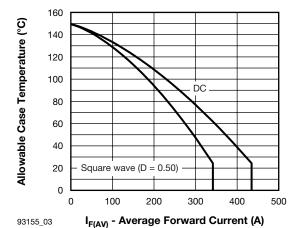


Fig. 3 - Maximum Allowable Case Temperature vs. Average Forward Current

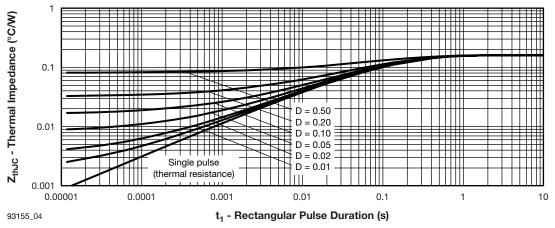


Fig. 4 - Maximum Thermal Impedance Z_{thJC} Characteristics

Vishay Semiconductors

INT-A-PAK Power Modules Ultrafast Diodes, 300 A



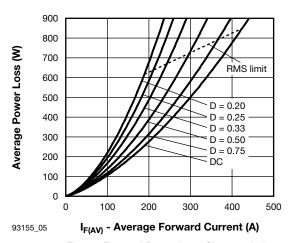


Fig. 5 - Forward Power Loss Characteristics

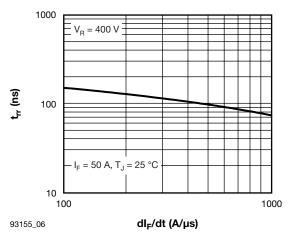


Fig. 6 - Typical Reverse Recovery Time vs. dl_F/dt (Per Leg)

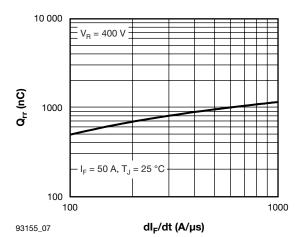


Fig. 7 - Typical Reverse Recovery Charge vs. dl_F/dt (Per Leg)

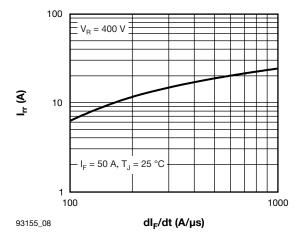


Fig. 8 - Typical Reverse Recovery Current vs. dl_F/dt (Per Leg)



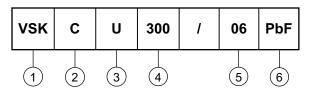


INT-A-PAK Power Modules Ultrafast Diodes, 300 A

Vishay Semiconductors

ORDERING INFORMATION TABLE

Device code



1 - Module type

2 - Circuit configuration:

C = 2 diodes common cathode

3 - U = Ultrafast diode

- Current rating (300 = 300 A)

- Voltage rating (06 = 600 V)

6 - PbF = Lead (Pb)-free

CIRCUIT CONFIGURATION



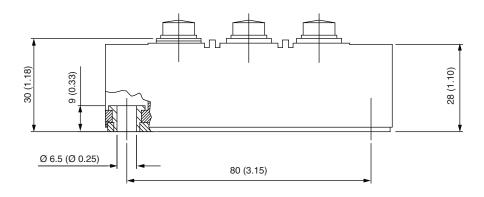
LINKS TO RELATED DOCUMENTS				
Dimensions	www.vishay.com/doc?95254			

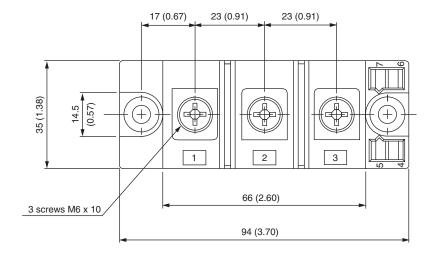


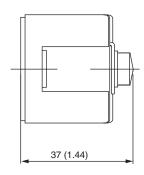
Vishay Semiconductors

INT-A-PAK DBC

DIMENSIONS in millimeters (inches)









Legal Disclaimer Notice

Vishay

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and/or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk and agree to fully indemnify and hold Vishay and its distributors harmless from and against any and all claims, liabilities, expenses and damages arising or resulting in connection with such use or sale, including attorneys fees, even if such claim alleges that Vishay or its distributor was negligent regarding the design or manufacture of the part. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

Material Category Policy

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as RoHS-Compliant fulfill the definitions and restrictions defined under Directive 2011/65/EU of The European Parliament and of the Council of June 8, 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment (EEE) - recast, unless otherwise specified as non-compliant.

Please note that some Vishay documentation may still make reference to RoHS Directive 2002/95/EC. We confirm that all the products identified as being compliant to Directive 2002/95/EC conform to Directive 2011/65/EU.